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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

DEC 0 2 2005

Applicants:

Bao, et al.

Docket No.:

TSM03-0927

Serial No.:

10/800,510

Art Unit:

2818

Filed:

March 15, 2004

Examiner:

Tu-Tu Ho

For:

Semiconductor Device Having a Second Level of Metallization Formed over a First Level with Minimal Damage to the First Level and Method

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Commissioner for Patents P. O. Box 1450

Alexandria, VA 22313-1450

Mail Stop: Amendment

AMENDMENT

Dear Sir:

The following amendments and remarks are presented in response to the Examiner's Office Action mailed August 3, 2005. Please amend the above-referenced application as follows.